The IEEE European Test Symposium (ETS) is Europe's premier forum dedicated to presenting and discussing scientific results, emerging ideas, hot topics, and new trends, industrial case-studies and applications, in the area of electronic-based circuits and system testing, reliability, safety, security and validation. The 2022 edition of ETS will be a hybride one.

ETS'23 is organized jointly by CNRS-INL and Politecnico di Torino, which co-sponsor the event together with the IEEE Council on Electronic Design Automation (CEDA). ETS'23 is technically sponsored by the IEEE Computer Society – Test Technology Technical Council (TTTC).

The program includes keynotes, scientific paper presentations, panels, tutorials, fringe workshops and highlights/demos from industry. Linked to the main ETS'23 symposium, the Test Spring School will be organized.

You are invited to participate and submit your contributions to ETS'23. The areas of interest include (but are not limited to) the following topics:

- **Dependable AI and AI for Testing (Hot Topic)**
- **Functional Safety and Reliability in Automotive (Hot Topic)**
- **Emerging technologies and architectures (Hot Topic)**
- **Security and Trust (Hot Topic)**
- **Analog, Mixed-Signal, RF**
- **Validation, Verification Debug and Diagnosis**
- **DFT and Test Access Standards**
- **Test generation, Fault Simulation, Fault Tolerance, Application and evaluation**

**Submissions:** ETS'23 seeks original, unpublished contributions of the following types:

- **Scientific Papers**, up to 6 pages, for inclusion in the Formal IEEE Proceedings
- **Industrial Papers**, up to 6 pages, for inclusion in the Informal Digest of Papers
- **Fringe Workshops proposals** about relevant and timely topics.

**Key dates:**

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<td>Title and abstract (Scientific papers)</td>
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<td>Notification of acceptance</td>
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**Additional information:** ETS'23 will produce Formal Proceedings of accepted scientific papers with ISBN number that will be included in the IEEE Xplore Digital Library. An Informal digest will be produced to include Industrial papers.

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